TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

## **TPCF8101**

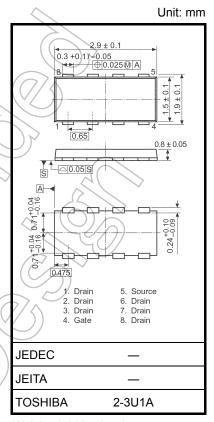
# Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance:  $R_{DS (ON)} = 22 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: |Y<sub>fs</sub>| = 14 S (typ.)
- Low leakage current:  $I_{DSS} = -10 \mu A \text{ (max)} (V_{DS} = -12 \text{ V})$
- Enhancement model:  $V_{th} = -0.5 \text{ to } -1.2 \text{ V}$

 $(V_{DS} = -10 \text{ V}, I_{D} = -200 \mu\text{A})$ 

#### **Absolute Maximum Ratings (Ta = 25°C)**

				////
Characte	ristics	Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	-12	V
Drain-gate voltage (R	GS = 20 kΩ)	V <sub>DGR</sub>	<del>-</del> 12	> V
Gate-source voltage		V <sub>GSS</sub>	±8	V
Drain current	DC (Note	) I <sub>D</sub>	-6	Λ
Drain current	Pulsed (Note	) I <sub>DP</sub> <	-24	
Drain power dissipation	on (t = 5 s (Note 2a		2.5	W
Drain power dissipation	on (t = 5 s (Note 2t		0.7	w
Single pulse avalanch	ne energy (Note 3	B) (EAS)	6.3	mJ
Avalanche current		lar	-3	A
Repetitive avalanche	energy (Note	) E <sub>AR</sub>	0.25	mJ
Channel temperature	// ) \_	T <sub>ch</sub>	150/	°C
Storage temperature	range	T <sub>stg</sub>	-55 to 150	°C



Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

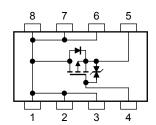
#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R <sub>th (ch-a)</sub>	50.0	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R <sub>th (ch-a)</sub>	178.6	°C/W

Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the third page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

#### **Circuit Configuration**



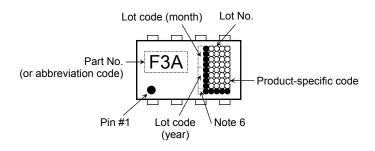
### **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rrent	I <sub>GSS</sub>	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ	
Drain cut-off curr	ent	I <sub>DSS</sub>	V <sub>DS</sub> = -12 V, V <sub>GS</sub> = 0 V	_	_	-10	μА	
Drain-source breakdown voltage		V <sub>(BR)DSS</sub>	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-12	_		V	
		V <sub>(BR)DSX</sub>	$I_D = -10$ mA, $V_{GS} = 8$ V	4			V	
Gate threshold vo	oltage	V <sub>th</sub>	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	0.5	) /_	-1.2	V	
		R <sub>DS</sub> (ON)	$V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$	) <sub>K</sub>	60	85	85	
Drain-source ON	resistance	R <sub>DS</sub> (ON)	$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$	$\rightarrow$	32	40	mΩ	
		R <sub>DS</sub> (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A}$	)	22	28		
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -3.0 \text{ A}$	7	14		S	
Input capacitance		C <sub>iss</sub>			1600	1		
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	260	Ŋ	pF	
Output capacitance		C <sub>oss</sub>			335			
Switching time	Rise time	t <sub>r</sub>	0 V T I <sub>D</sub> = -3.0 A	2 V	40	-		
	Turn-on time	t <sub>on</sub>	VGS -5 V OUT	7	13	l	no	
	Fall time	t <sub>f</sub>	G.Y.4.		21		ns	
	Turn-off time	toff	$V_{DD} \simeq -6 \text{ V}$ Duty $\leq$ 1%, $t_W = 10 \mu\text{s}$	_	68			
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -10 \text{ V}, V_{GS} = -5 \text{ V},$	_	18.0	_		
Gate-source charge		Qgs	$I_D = -6.0 \text{ A}$	_	14.5	_	nC	
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	3.5	_		

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	\ I <sub>DRP</sub>	_			-24	Α
Forward voltage	(diode)	V <sub>DSF</sub>	$I_{DR} = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

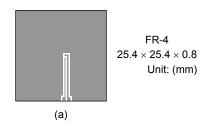
#### Marking (Note 5)

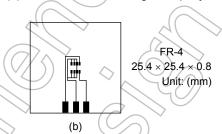


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)





Note 3:  $V_{DD} = -10 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 0.5 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -3.0 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: A dot on the lower left of the marking indicates Pin 1.

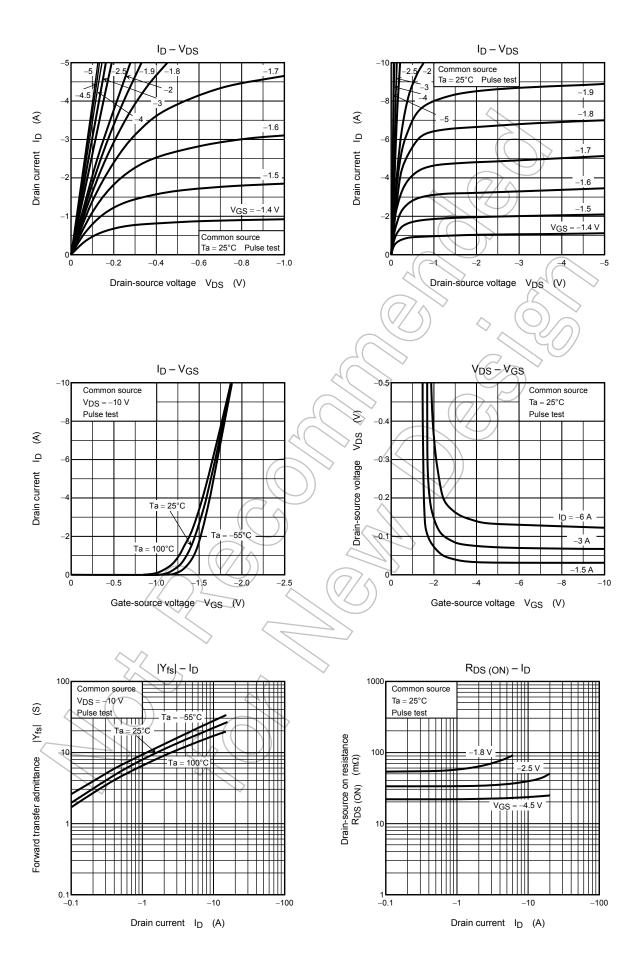
Note 6: A dot marking for identifying the indication of product Labels.

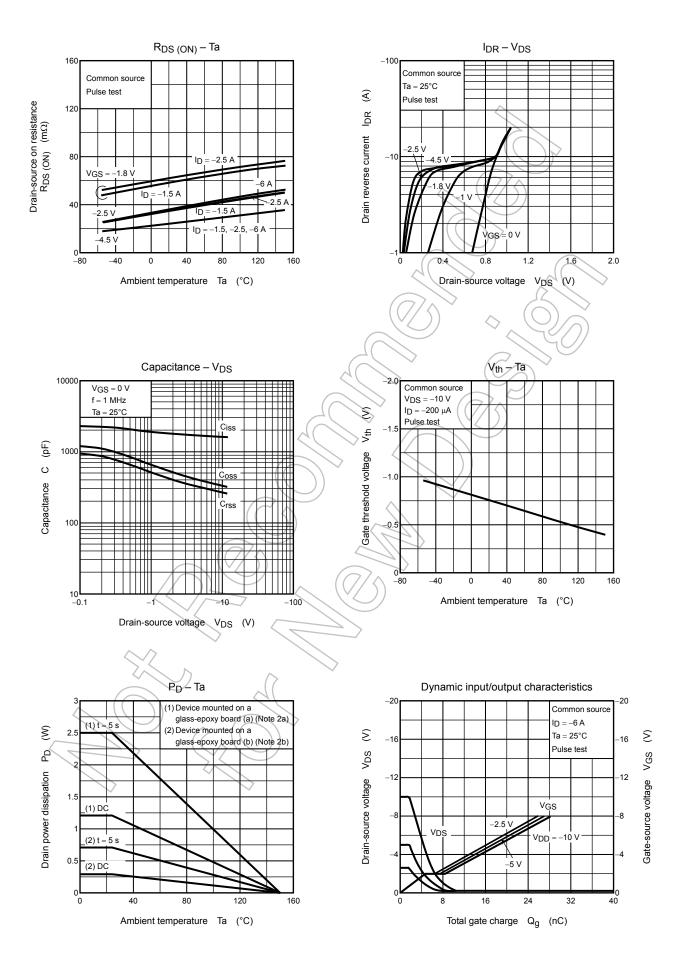
Without a dot: [[Pb]]/INCLUDES > MCV

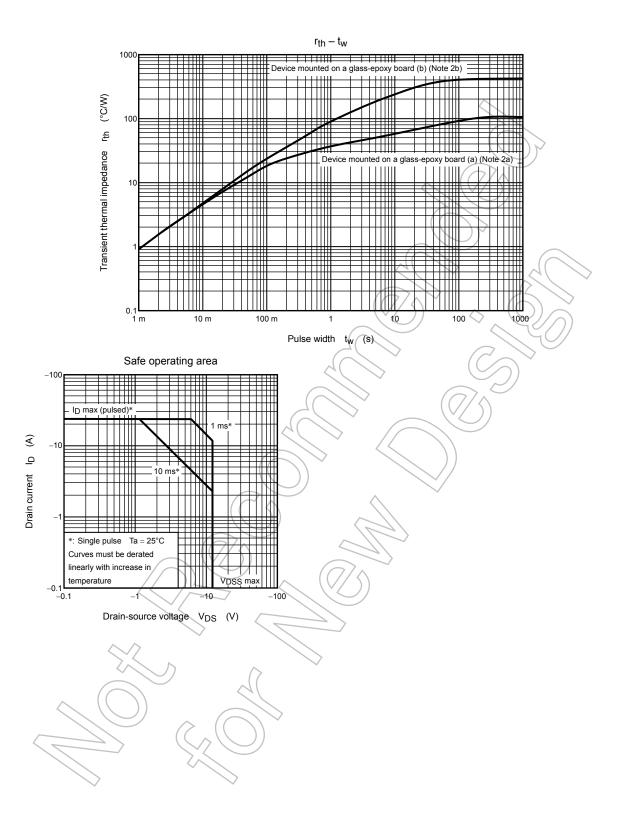
With a dot: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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